## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT5043257

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
AN-REN ZI	06/28/2018
CHING-YU CHANG	06/28/2018
CHIN-HSIANG LIN	06/28/2018

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300-78	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16021665

#### CORRESPONDENCE DATA

Fax Number: (703)205-8050

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7032058000

Email: mailroom@bskb.com, phillip.tashjian@bskb.com BIRCH, STEWART, KOLASCH & BIRCH, LLP. **Correspondent Name:** 

Address Line 1: 8110 GATEHOUSE ROAD, SUITE 100E Address Line 4: FALLS CHURCH, VIRGINIA 22040-0747

ATTORNEY DOCKET NUMBER:	0941-3659PUS2	
NAME OF SUBMITTER:	PHILLIP R. TASHJIAN	
SIGNATURE:	/Phillip R. Tashjian/	
DATE SIGNED:	07/10/2018	

**Total Attachments: 2** 

source=2018-07-10\_AssignmentAsfiled\_0941-3659PUS2#page1.tif source=2018-07-10 AssignmentAsfiled 0941-3659PUS2#page2.tif

**PATENT REEL: 046306 FRAME: 0520** 504996509



### ASSIGNMENT

WHEREAS, An-Ren ZI, Ching-Yu CHANG and Chin-Hsiang LIN

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

# Title: METHOD FOR FORMING SEMICONDUCTOR STRUCTURE

Filed: June 28, 2018	Serial No. 16/021 665
Julie 20, 2010	10/021,005
Executed on: June 28, 2018	
***************************************	

WHEREAS, <u>Taiwan Semiconductor Manufacturing Co., Ltd.</u>, of <u>No. 8, Li-Hsin Rd. 6, Hsinchu Science Park</u>, <u>Hsinchu 300-78</u>, <u>Taiwan R.O.C.</u>, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

P20172559US00/0503-B32877-US

Page 1 of 2

PATENT REEL: 046306 FRAME: 0521

## ASSIGNMENT

2018/6/28 An-Ren Zi

Name: An-Ren Zi

P20172559US00/0503-B32877-US

Page 2 of 2

**PATENT** REEL: 046306 FRAME: 0522